

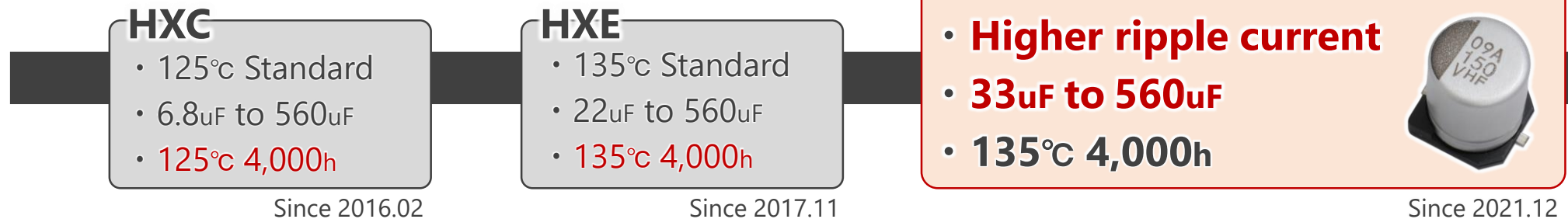
## ● Feature

- ☑ Endurance: 135°C 4,000h (with ripple)
- ☑ Voltage: 25V<sub>dc</sub> to 63V<sub>dc</sub>
- ☑ Capacitance: 33μF to 560μF
- ☑ Size: φ8×10L to φ10×16.5L
- ☑ Bias humidity: 85°C/85%RH 2,000h
- ☑ Guranteed short time operating temp. 150°C  
(150°C300h+135°C3,000h)

## ● Product Chart

- ☑ Recommended to replace in HXC/HXE to HXF

\*Lineup for high heat resistance/super low ESR (SMD type)



## ● Recommend Application

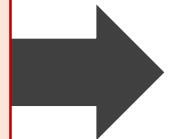
- ☑ For high temperature / High reliability usage
- ☑ For automotive (Ex. DC-LINK)
- ☑ For power supplies (Base station)

2022.08

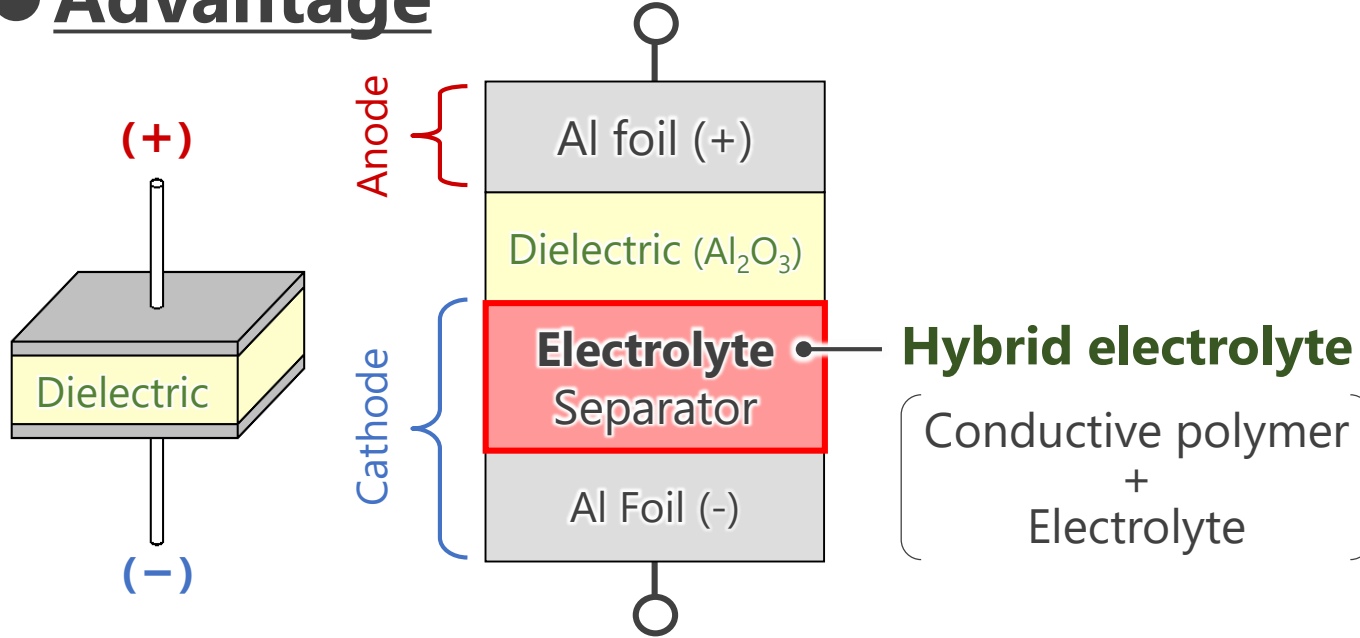
**Upgrade!**

**HXF**

- Added new case size  
(φ10×12.5L , φ10×16.5L)
- Guranteed short time 150°C
- Higher ripple current
- 33μF to 560μF
- 135°C 4,000h



## ● Advantage



Conventional  
**HXE**

### 【 Key Technologies 】

#### Electrolyte

- Newly developed

#### Sealing rubber

- Newly developed

### ☑ Three advantages of HXF



- ① Super low ESR above 25v
- ② Wear-out failure (Open Circuit & Safety)
- ③ Higher ripple current

**HXF**

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**Upgrade!**

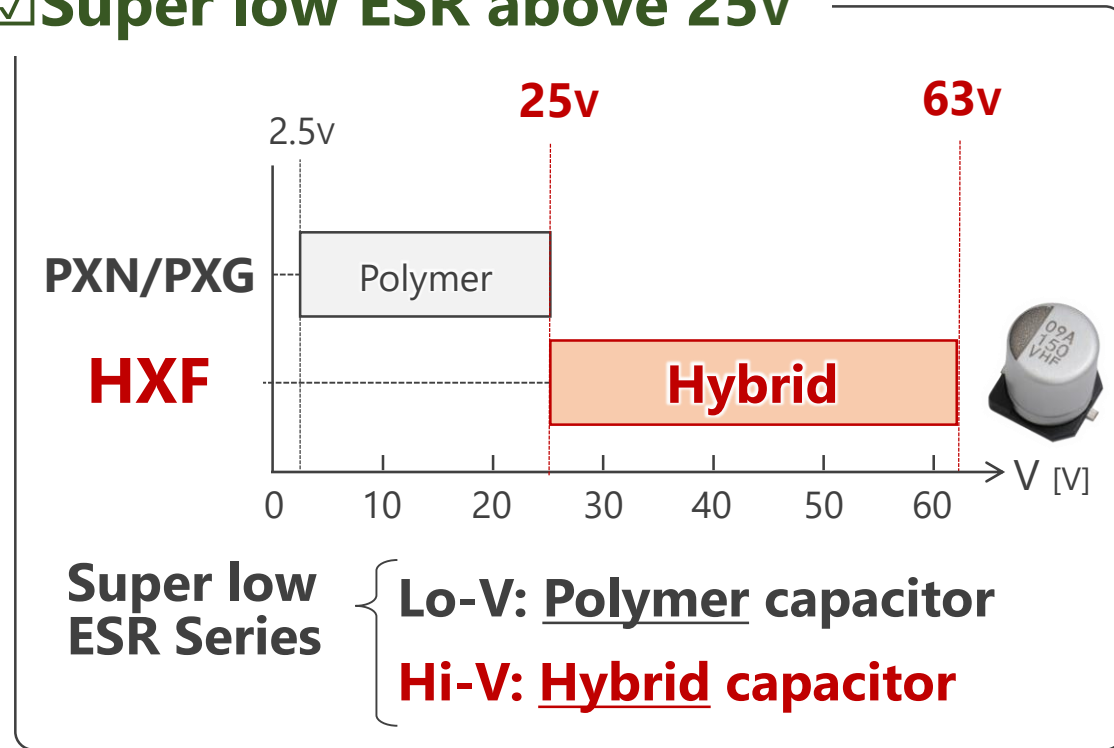
Added new case size  
(Φ10×12.5L , Φ10×16.5L)

## ● Benefit/Evidence

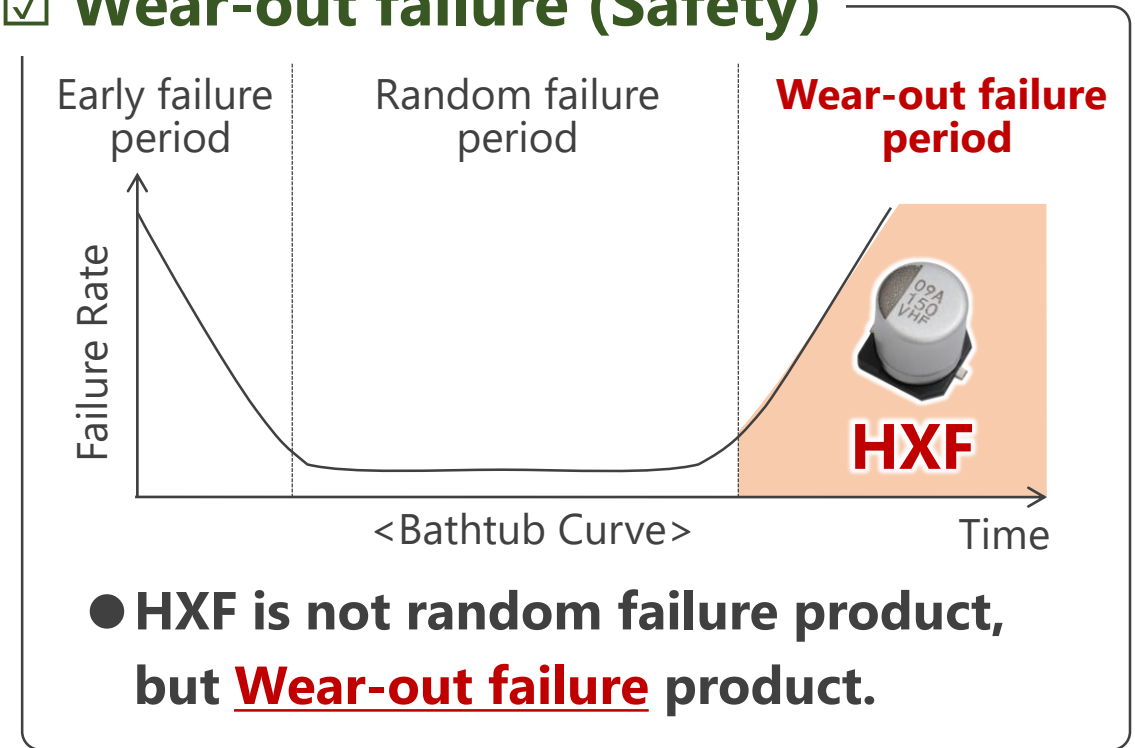
- ➔ ① **Super low ESR above 25v** / ② **Wear-out failure (Open circuit & Safety)**
- ③ Higher ripple current · · Downsizing, Reduced # of capacitors



### ☑ Super low ESR above 25v



### ☑ Wear-out failure (Safety)



## ● Benefit/Evidence

① Super low ESR above 25v / ② Wear-out failure (Open circuit & Safety)

➔ ③ **Higher ripple current** · · **Downsizing, Reduced # of capacitors**

